



PITT-11-11-048

November 18, 2011

Project No. 112G02122

Mr. Howard Hickey NAVFAC MW Building 1A, Code EV 201 Decatur Avenue Great Lakes. Illinois 60088

Reference:

CLEAN Contract No. N62470-08-D-1001

Contract Task Order No. F274

Subject:

**Final** Tier II Sampling and Analysis Plan (SAP) and Response to Comments (RTC) for Soil Contamination Delineation for Corrective Measures Design at the Old Jeep Trail Treatment Area of SWMU 3 – Ammunition Burning Grounds/Old Jeep Trail, Naval

Support Activity Crane, Crane, Indiana

Dear Mr. Hickey:

The Draft Tier II SAP for The Old Jeep Trail Treatment Area of SWMU 3 – Ammunition Burning Grounds/Old Jeep was submitted to the Navy on June 1, 2011. The Navy ERSM comments were received on June 8, 2011. The Navy Chemist comments were received on June 22, 2011. Tetra Tech submitted the revised SAP and RTC to the Navy on July 6, 2011. The Navy Chemist approved the revised SAP on July 15, 2011. The Draft Final Tier II SAP and RTC for The Old Jeep Trail Treatment Area of SWMU 3 was submitted on August 3, 2011. USEPA (EPA) Region 5 comments were received on November 7, 2011. The draft response to EPA comments were submitted by the Navy to EPA on November 14, 2011 and approved on November 16, 2011. The final response to EPA comments is attached. Enclosed is a hard copy and an electronic copy (CD) of the final SAP.

Please contact the undersigned at (412) 921-8308 (email: <u>Ralph.Basinski@tetratech.com</u>) or John Ducar at (412) 921-8089 (email: <u>John.Ducar@tetratech.com</u>) regarding any questions or comments.

Sincerely

Ralph R. Basinski Project Manager

RRB/mlg Enclosures

cc:

Mr. Tom Brent, NSA Crane (letter, attachment, 4 enclosures and CDs)

Mr. John Trepanowski, Tetra Tech (letter only)

Mr. Ralph Basinski, Tetra Tech (letter, attachment, enclosure and CD)

Mr. Tony Klimek, Tetra Tech (letter, attachment, enclosure and CD)

Mr. John Ducar, Tetra Tech (letter)

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Mr. Glenn Wagner, Tetra Tech (letter, attachment, enclosure and CD)

Project File – CTO F274 (letter, attachment, enclosure and CD)

Tetra Tech